

General Description

The WSR180N08 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSR180N08 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Product Summary

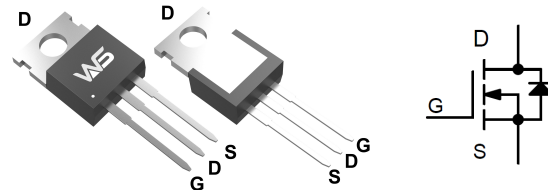
BV_{DSS}	R_{DSON}	I_D
85V	3.2mΩ	180A

Applications

Switching application

Power Management for Inverter Systems.

TO-220AB-3L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	85	V
V_{GS}	Gate-Source Voltage	±20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	180	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	125	A
I_{DM}	Pulsed Drain Current ² , $T_C=25^\circ C$	00	A
EAS	Avalanche Energy, Single pulse, L=0.5mH	1406	mJ
I_{AS}	Avalanche Current, Single pulse, L=0.5mH	5	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	250	W
$P_D@T_C=100^\circ C$	Total Power Dissipation	100	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	---	62.5	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case	---	0.5	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	85	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C, I _D =1mA	---	0.096	---	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =40A	---	3.2	4.0	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	2.0	3.0	4.0	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-5.5	---	mV/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =80V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =80V, V _{GS} =0V, T _J =55°C	---	---	10	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±25V, V _{DS} =0V	---	---	±100	nA
R _g	Gate Resistance	V _{DS} =0V, V _{GS} =0V, f=1MHz	---	1.2	---	Ω
Q _g	Total Gate Charge (10V)	V _{DS} =30V, V _{GS} =10V, I _D =40A	---	95	---	nC
Q _{gs}	Gate-Source Charge		---	28	---	
Q _{gd}	Gate-Drain Charge		---	23	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =30V, V _{GS} =10V, R _G =6Ω, I _D =1A	---	27	---	ns
T _r	Rise Time		---	18	---	
T _{d(off)}	Turn-Off Delay Time		---	140	---	
T _f	Fall Time		---	94	---	
C _{iss}	Input Capacitance	V _{DS} =30V, V _{GS} =0V, f=1MHz	---	6750	---	pF
C _{oss}	Output Capacitance		---	945	---	
C _{rss}	Reverse Transfer Capacitance		---	258	---	

Guaranteed Avalanche Characteristics

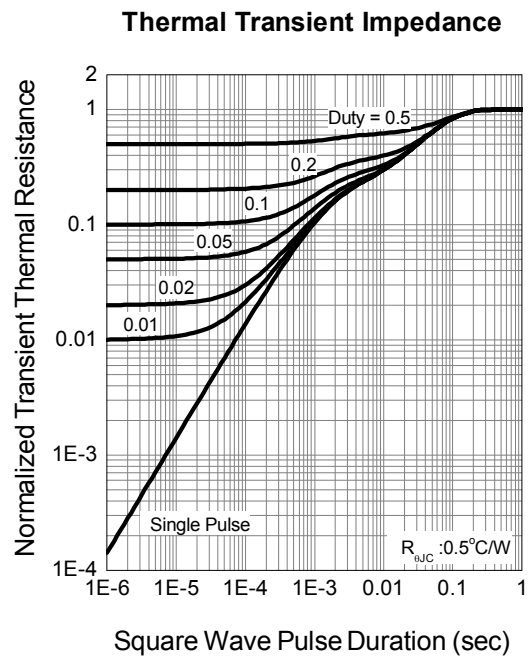
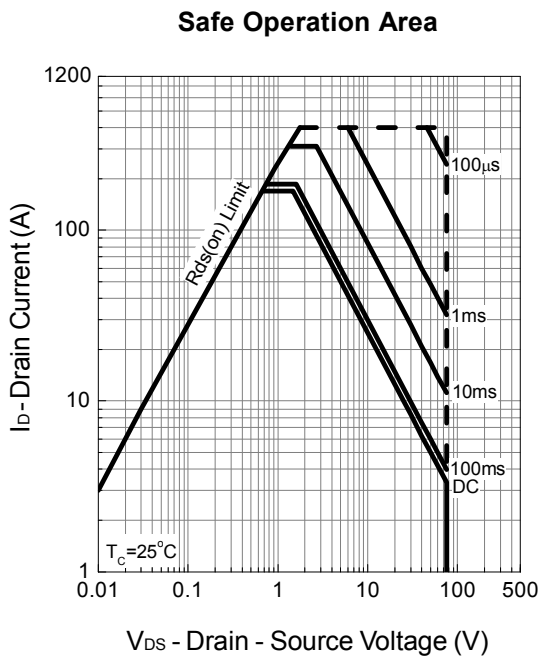
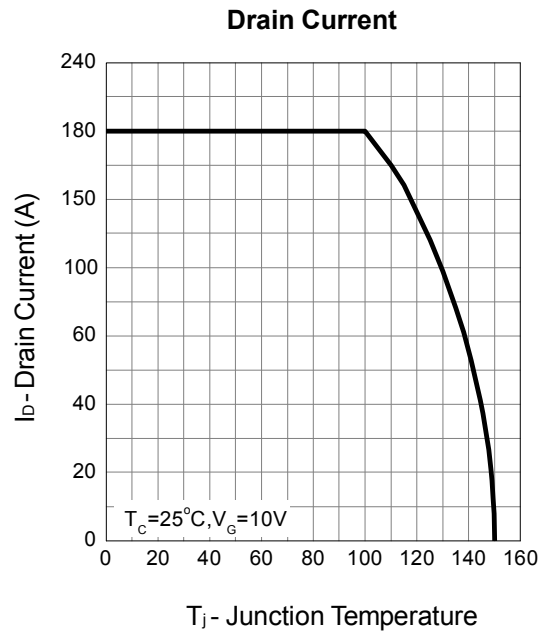
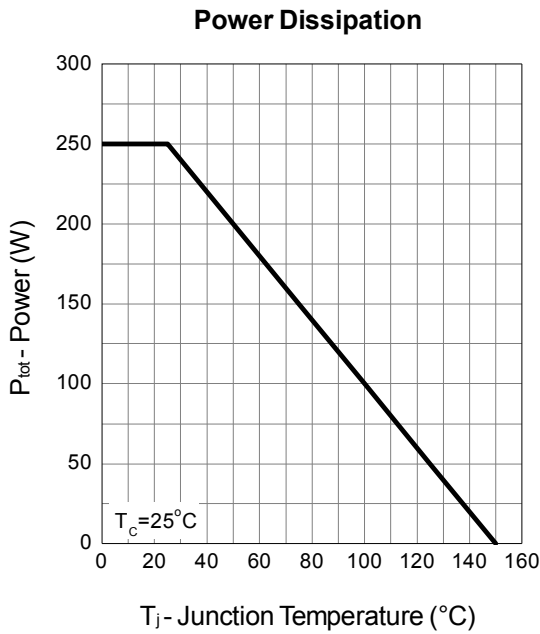
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy	V _{DD} =40V, L=0.5mH, I _{AS} = 5A	1000	---	---	mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	80	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =40A, T _J =25°C	---	---	1.2	V
t _{rr}	Reverse Recovery Time	I _F =40A, dI/dt=100A/μs, T _J =25°C	---	58	---	nS
Q _{rr}	Reverse Recovery Charge		---	135	---	nC

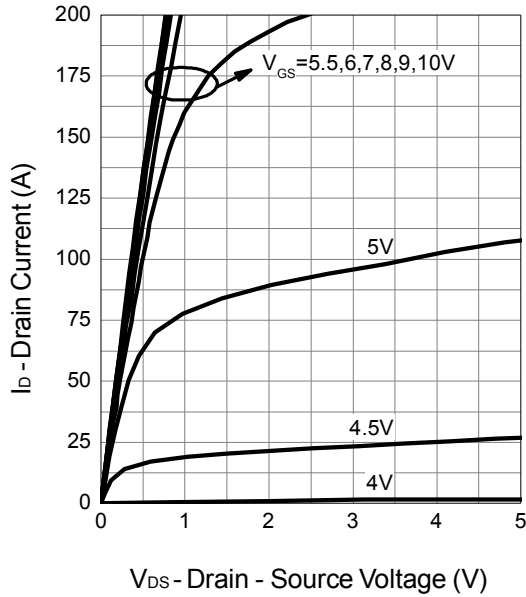
Note * : Pulse test ; pulse width ≤300μs, duty cycle ≤2%.

Typical Operating Characteristics

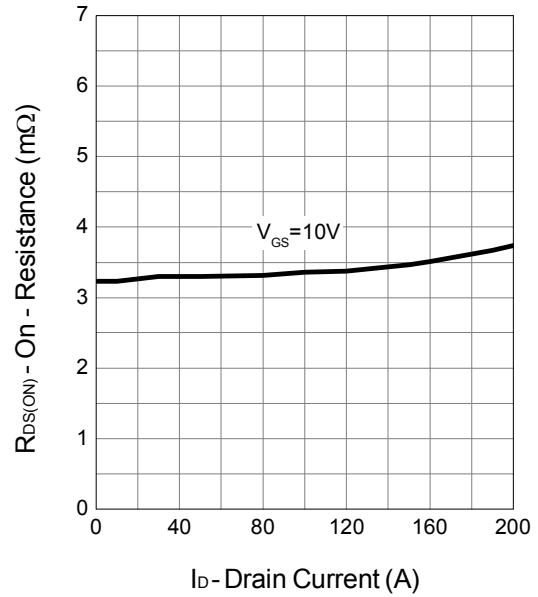


Typical Operating Characteristics

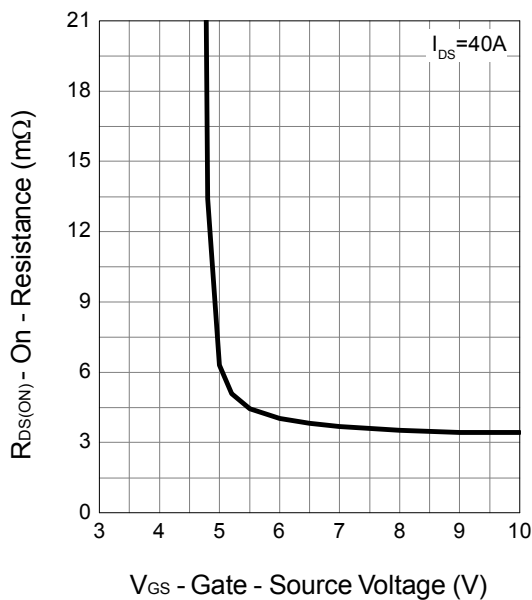
Output Characteristics



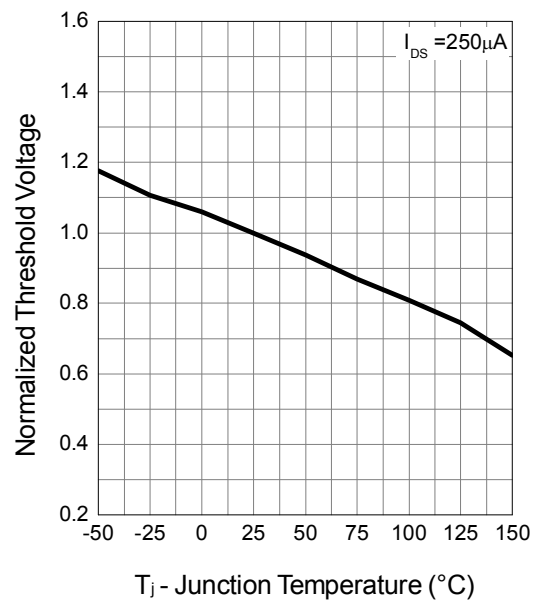
Drain-Source On Resistance



Gate-Source On Resistance

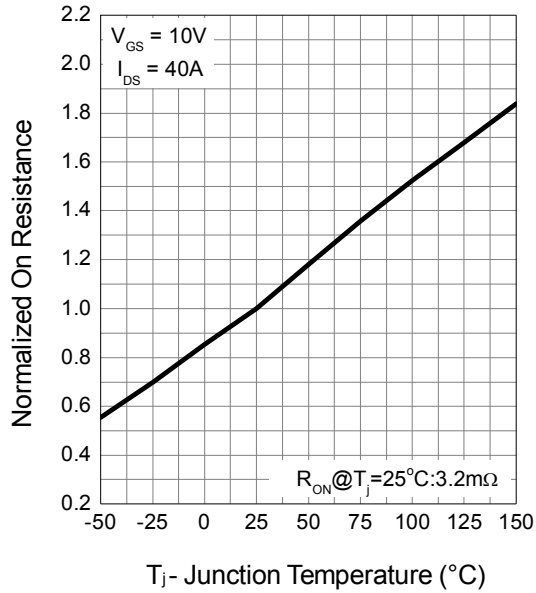


Gate Threshold Voltage

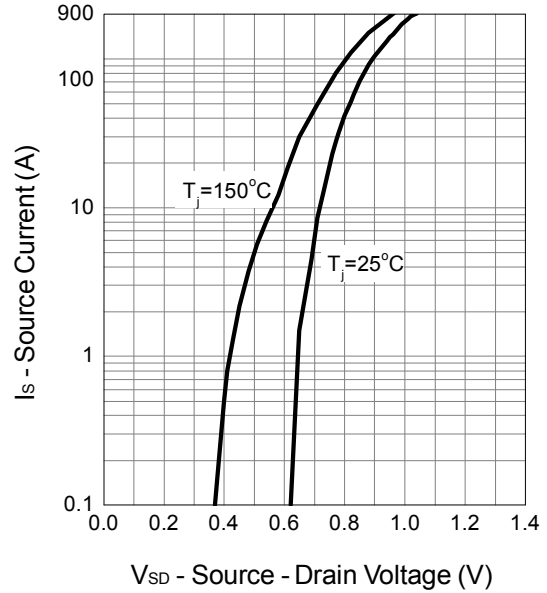


Typical Operating Characteristics

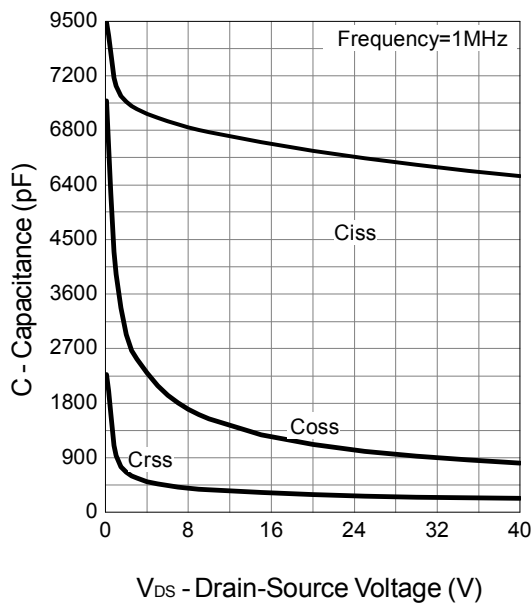
Drain-Source On Resistance



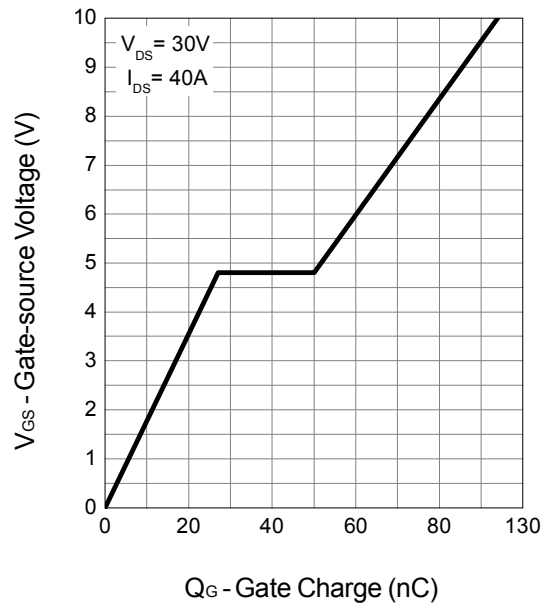
Source-Drain Diode Forward



Capacitance



Gate Charge





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